

APPLICABLE STANDARD					
RATING	OPERATING TEMPERATURE RANGE	-55 °C TO 85 °C ⁽¹⁾	STORAGE TEMPERATURE RANGE	-10 °C TO 60 °C ⁽²⁾	
	VOLTAGE	50 V AC	STORAGE HUMIDITY RANGE	RELATIVE HUMIDITY 85% max (NOT DEWED)	
	CURRENT	0.5 A	OPERATING HUMIDITY RANGE		
SPECIFICATIONS					
ITEM		TEST METHOD	REQUIREMENTS	QT	AT
CONSTRUCTION					
GENERAL EXAMINATION		VISUALLY AND BY MEASURING INSTRUMENT.	ACCORDING TO DRAWING.	x	x
MARKING		CONFIRMED VISUALLY.		x	x
ELECTRIC CHARACTERISTICS					
CONTACT RESISTANCE		100 mA(DC OR 1000Hz)	70 mΩ MAX .	x	—
INSULATION RESISTANCE		100 V DC.	100 MΩ MIN.	x	—
VOLTAGE PROOF		150 V AC FOR 1 min.	NO FLASHOVER OR BREAKDOWN.	x	x
MECHANICAL CHARACTERISTICS					
INSERTION AND WITHDRAWAL FORCES		MEASURED BY APPLICABLE CONNECTOR.	INSERTION FORCE: 84 N MAX. WITHDRAWAL FORCE: 10.3 N MIN.	x	—
MECHANICAL OPERATION		50 TIMES INSERTIONS AND EXTRACTIONS.	① CONTACT RESISTANCE: Δ VARIATION FROM INITIAL VALUE 20 mΩ OR LESS. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	x	—
VIBRATION		FREQUENCY 10 TO 55 TO 10Hz, APPROX 5min SINGLE AMPLITUDE : 0.75 mm, 10 CYCLES FOR 3 DIRECTIONS.	① NO ELECTRICAL DISCONTINUITY OF 1 μs. ② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	x	—
SHOCK		490 m/s ² , DURATION OF PULSE 11 ms AT 3 TIMES FOR 3 DIRECTIONS.		x	—
ENVIRONMENTAL CHARACTERISTICS					
DAMP HEAT (STEADY STATE)		EXPOSED AT 40±2 °C, 90 ~ 95 %, 96 h.	① CONTACT RESISTANCE: Δ VARIATION FROM INITIAL VALUE 20 mΩ OR LESS.	x	—
RAPID CHANGE OF TEMPERATURE		TEMPERATURE -55 → +85 °C TIME 30 → 30 min. UNDER 5 CYCLES. (RELOCATION TIME TO CHAMBER:WITHIN 2~3 MIN)	② INSULATION RESISTANCE :100 MΩ MIN. ③ NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	x	—
COLD		EXPOSED AT -55°C, 96 h	① CONTACT RESISTANCE: Δ VARIATION FROM INITIAL VALUE 20 mΩ OR LESS.	x	—
DRY HEAT		EXPOSED AT 85°C, 96 h	② NO DAMAGE, CRACK AND LOOSENESS OF PARTS.	x	—
SULFUR DIOXIDE		EXPOSED AT 25±2°C, 75±5%RH, 25 PPM FOR 96 h. (TEST STANDARD: JIS C 60068)	① NO DEFECT SUCH AS CORROSION WHICH IMPAIRS THE FUNCTION OF CONNECTOR. ② CONTACT RESISTANCE: Δ VARIATION FROM INITIAL VALUE 20 mΩ OR LESS.	x	—
RESISTANCE TO SOLDERING HEAT		1)REFLOW SOLDERING : PEAK TMP : 260°C MAX REFLOW TMP: 220°C MIN FOR 60sec 2) SOLDERING IRONS : 360°C MAX. FOR 5 sec.	NO DEFORMATION OF CASE OF EXCESSIVE LOOSENESS OF THE TERMINAL.	x	—
SOLDERABILITY		SOLDERED AT SOLDER TEMPERATURE 240±3°C FOR IMMERSION DURATION, 3 sec.	A NEW UNIFORM COATING OF SOLDER SHALL COVER A MINIMUM OF 95 % OF THE SURFACE BEING IMMERSED.	x	—
	COUNT	DESCRIPTION OF REVISIONS	DESIGNED	CHECKED	DATE
Δ	4	DIS-F-005857	KT. D01	KI. HIROKAWA	11. 11. 24
REMARKS ⁽¹⁾ INCLUDE TEMPERATURE RISE CAUSED BY CURRENT-CARRYING. ⁽²⁾ "STORAGE" MEANS A LONG-TERM STORAGE STATE FOR THE UNUSED PRODUCT BEFORE ASSEMBLY TO PCB. Unless otherwise specified, refer to JIS-C-5402.			APPROVED	HS. OKAWA	11. 08. 22
			CHECKED	KI. HIROKAWA	11. 08. 12
			DESIGNED	KT. D01	11. 08. 12
			DRAWN	KT. D01	11. 08. 12
Note QT:Qualification Test AT:Assurance Test X:Applicable Test			DRAWING NO.		ELC4-336329-00
	SPECIFICATION SHEET		PART NO.	FX20-120P-0. 5SV20	
	HIROSE ELECTRIC CO., LTD.		CODE NO.	CL570-1011-4-00	Δ 1/1